

81788.0023

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Seiichi Mori

Serial No: 09/451,619

Filed: November 30, 1999

NON-VOLATILE For:

SEMICONDUCTOR MEMORY AND

MANUFACTURING METHOD

**THEREOF** 

Examiner: Not Assigned

Art Unit: 2824

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Assistant Commissioner for Patents Washington D.C. 20231, on

Date

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TRANSMITTAL OF INFORMATION DISCLOSURE **STATEMENT** 

**Assistant Commissioner for Patents** Washington, D.C. 20231

Dear Sir:

The information disclosure statement submitted herewith is being filed before a first action on the merits for the subject application and contains no items of information cited in any communication from a foreign patent office in a counterpart foreign application [37 C.F.R. § 1.97(e)(1)].

If it should be determined that for any reason either an insufficient or excessive fee has been paid, please charge any insufficiency or credit any overpayment necessary to ensure consideration of the information disclosure statement for the above-identified application to Deposit Account No. 50-1314. A copy of this paper is enclosed.

Respectfully submitted,

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Date: May 2, 2000

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